DS90C031,DS90C032

LVDS Performance: Bit Error Rate (BER) Testing Test Report #2



Literature Number: SNLA154

LVDS Performance: Bit Error Rate (BER) Testing Test Report #2

LVDS CABLE DRIVING PERFORMANCE

This report provides the results of a series of Bit Error Rate tests performed on the DS90C031/2 LVDS Quad Line Drive/Receiver devices. Four drivers were used to drive 1 to 5 meters of standard twisted pair cables at selected data rates. Four receivers were used to recover the data at the load end of the cable.

The questions of: How Far? and How Fast? seem simple to answer at first, but after detailed study their answers become quite complex. This is not a simple device parameter specification. But rather, a system level question, and to be answered correctly a number of other parameters besides the switching characteristics of the drivers and receivers must be known. This includes the measurement criteria for signal quality that has been selected, and the pulse coding that will be used (NRZ for example). Additionally, other system level components should be known too. This includes details about the cable, connector, and information about the printed circuit board (PCB). Since the purpose is to measure signal quality/performance, it should be done in a test fixture that matches the end environment precisely if possible. The actual application would be the best test set up. There are numerous methods to measure signal quality, including eye pattern (jitter) measurements and Bit Error Rate tests (BER).

WHAT IS A BER TEST?

Bit Error Rate testing is one way to measure the performance of a communications system. The standard equation for a bit error rate measurement is:

Bit Error Rate = $\frac{\text{(Number of Bit Errors)}}{\text{(Total Number of Bits)}}$

Common measurement points are bit error rates of:

National Semiconductor Application Note 1040 John Goldie Mike Wilson May 1996



 \le 1 x 10⁻¹² → One or less errors in 1 trillion bits sent \le 1 x 10⁻¹⁴ → One or less errors in 100 trillion bits sent

Note that BER testing is time intensive. The time length of the test is determined by the data rate and also the desired performance bench mark. For example if the data rate is 50 Mbps, and the bench mark is an error rate of 1 x 10^{-14} or better, a run time of 2,000,000 seconds is required for a serial channel. 2,000,000 seconds equates to 555.6 hours or 23.15 days!

BER TEST CIRCUIT

LVDS drivers and receivers are intended to be primarily used in an uncomplicated point-to-point configuration as shown in *Figure 1*. This figure details the test circuit that was used. It includes the following components:

PCB#1: DS90C031 LVDS Quad Driver soldered to the PCB with matched PCB traces between the device (located near the edge of the PCB) to the connector. The connector is an AMP amplite 50 series connector.

Cable: Cable used for this testing was Berk-Tek part number 271211. This is a 105Ω (Differential Mode) 28 AWG stranded twisted pair cable (25 Pair with overall shield) commonly used on SCSI applications. This cable represents a common data interface cable. For this test report cable lengths of 1 and 5 meters were tested.

PCB#2: DS90C032 LVDS Quad Receiver soldered to the PCB with matched PCB traces between the device (located near the edge of the PCB) to the connector. The connector is a AMP amplite 50 series connector. A 100Ω surface mount resistor was used to terminate the cable at the receiver input pins.

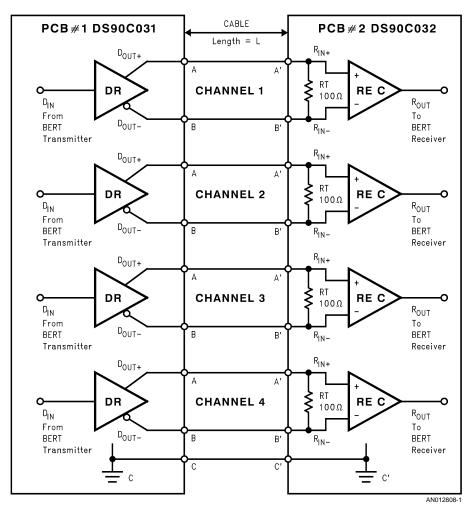


FIGURE 1. LVDS BER Test Circuit

TEST PROCEDURE

A parallel high-speed BER transmitter/receiver set (Tektronix MultiBERT-100) was employed for the tests. The transmitter was connected to the driver inputs, and the receiver outputs were connected to the BERT receiver inputs. Different cable lengths and data rates were tested. The BER tester was configured to provide a PRBS (Pseudo Random Bit Sequence) of $2^{15} - 1$ (32,767 bit long sequence). In the first test, the same input signal was applied to all four of the LVDS channels under test. For the other tests, the PRBS was offset by 4 bits, thus providing a random sequence between channels. The coding scheme used was NRZ. Upon system test configuration, the test was allowed to run uninterrupted for a set amount of time. At completion of the time block, the results were recorded, which included: elapsed seconds, total bits transmitted, and the number of bit errors recorded. For the three tests documented below, a power supply voltage of +5.0V was used, and the tests were conducted at room temperature.

TESTS AND RESULTS

The goal of the tests was to demonstrate error rates of less that $<1 \times 10^{-12}$ are obtainable.

TEST #1 Conditions:

Data Rate = 50 Mbps

Cable Length = 1 meter

PRBS Code = 2¹⁵ - 1 NRZ

For this test, the PRBS code applied to the four driver inputs was identical. This created a SOS (Simultaneous Output Switching) condition on the device.

TEST #1 Results:

Total Seconds: 87,085 (1 day)

Total Bits: 1,723 x 10¹³

Errors = 0

Error Rate = $<1 \times 10^{-12}$

TEST #2 Conditions:

Data Rate = 100 Mbps

Cable Length = 1 meter

PRBS Code = $2^{15} - 1$ NRZ

www.national.com 2

For this test, the PRBS code applied to the four driver inputs was offset by four bits. This creates a random pattern between channels.

TEST #2 Results:

Total Seconds: 10,717 (~3 hr.)

Total Bits: 4.38 x 10¹²

Errors = 0

Error Rate = $<1 \times 10^{-12}$

TEST #3 Conditions:

Data Rate = 100 Mbps Cable Length = 5 meter PRBS Code = 2¹⁵ - 1 NRZ

For this test, the PRBS code applied to the four driver inputs was offset by four bits. This creates a random pattern between channels.

TEST #3 Results:

Total Seconds: 10.050 Total Bits: 4 x 10¹²

Errors = 0

Error Rate = $<1 \times 10^{-12}$

CONCLUSIONS

All three of the tests ran error free and have demonstrated low bit error rates using LVDS technology. Thus the tests concluded error rates of $<1 \times 10^{-12}$ can be obtained at 100 Mbps operation across 5 meters of twisted pair cable. BER tests only provide a Go-No Go (Pass-Fail) data point if zero errors are detected. It is recommended to conduct further tests to determine the point of failure (data errors). This will yield important data that indicates the amount of margin in the system. This was done in the tests conducted by increasing the cable length from 1 meter to 5 meters, and also adjusting the data rate from 50 Mbps to 100 Mbps. Additionally, bench checks were made while adjusting the power supply voltage from 5.0V to 4.5V and 5.5V, adjusting clock frequency, and by applying heat/cold to the DUT (Device Under Test). No errors were detected during these checks (tests were checks only and were not conducted over time, i.e. 24 hours). BER tests conclude that the PRBS patterns were transmitted error free across the link. This was concluded by applying a pattern to the input and monitoring the receiver output signal. BER tests do not measure the signal fidelity on the LVDS interconnect directly. Additional tests are recommended to conclude that the signal quality on the interconnecting media also meets system requirements.

REFERENCES

To probe further the following National Semiconductor Application Notes are recommended which are all located in the INTERFACE Databook:

AN-808 Long Transmission Lines and Data Signal Quality

AN-916 A Practical Guide to Cable Selection

AN-977 LVDS Signal Quality: Jitter Measurements Using Eye Patterns Test Report #1

LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



National Semiconductor Corporation Americas

Tel: 1-800-272-9959 Fax: 1-800-737-7018 Email: support@nsc.com www.national.com

National Semiconductor Europe

Fax: +49 (0) 180-530 85 86 Email: europe.support@nsc.com

Deutsch Tel: +49 (0) 69 9508 6208 English Tel: +44 (0) 870 24 0 2171 Français Tel: +33 (0) 1 41 91 8790

National Semiconductor Asia Pacific Customer Response Group Tel: 65-2544466 Fax: 65-2504466

Email: ap.support@nsc.com

National Semiconductor Tel: 81-3-5639-7560 Fax: 81-3-5639-7507

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products	Applications		

www.ti.com/audio www.ti.com/communications Audio Communications and Telecom **Amplifiers** amplifier.ti.com Computers and Peripherals www.ti.com/computers dataconverter.ti.com Consumer Electronics www.ti.com/consumer-apps **Data Converters DLP® Products** www.dlp.com **Energy and Lighting** www.ti.com/energy DSP dsp.ti.com Industrial www.ti.com/industrial Clocks and Timers www.ti.com/clocks Medical www.ti.com/medical

Clocks and Timers www.ti.com/clocks Medical www.ti.com/medical Interface interface.ti.com Security www.ti.com/security

Logic Space, Avionics and Defense www.ti.com/space-avionics-defense

Power Mgmt power.ti.com Transportation and Automotive www.ti.com/automotive
Microcontrollers microcontroller.ti.com Video and Imaging www.ti.com/video

RFID <u>www.ti-rfid.com</u>
OMAP Mobile Processors www.ti.com/omap

Wireless Connectivity www.ti.com/wirelessconnectivity

TI E2E Community Home Page <u>e2e.ti.com</u>